



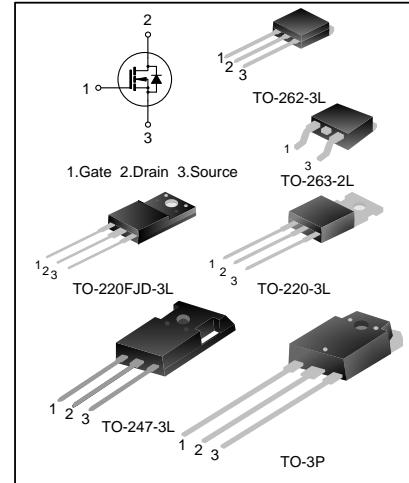
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Microelectronics **SVSP20N60FJD(K)(T)(PN)(S)(P7)D2_Datasheet**

20A, 600V SUPER JUNCTION MOS POWER TRANSISTOR

GENERAL DESCRIPTION

SVSP20N60FJD(K)(T)(PN)(S)(P7)D2 is an N-channel enhancement mode high voltage power MOSFETs produced using Silan's super junction MOS technology. It achieves low conduction loss and switching losses. It leads the design engineers to their power converters with high efficiency, high power density, and superior thermal behavior. Furthermore, it's universal applicable, for example. it is suitable for hard and soft switching topologies.



FEATURES

- 20A, 600V, $R_{DS(on)(typ.)}=0.16\Omega$ @ $V_{GS}=10V$
- New revolutionary high voltage technology
- Ultra low gate charge
- Periodic avalanche rated
- Extreme dv/dt rated
- High peak current capability

ORDERING INFORMATION

Part No.	Package	Marking	Hazardous Substance Control	Packing Type
SVSP20N60FJDD2	TO-220FJD-3L	P20N60FJD	Halogen free	Tube
SVSP20N60KD2	TO-262-3L	P20N60KD2	Halogen free	Tube
SVSP20N60TD2	TO-220-3L	P20N60TD2	Halogen free	Tube
SVSP20N60PND2	TO-3P	P20N60PN	Halogen free	Tube
SVSP20N60SD2	TO-263-2L	P20N60SD2	Halogen free	Tube
SVSP20N60SD2TR	TO-263-2L	P20N60SD2	Halogen free	Tape&Reel
SVSP20N60P7D2	TO-247-3L	P20N60	Halogen free	Tube



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Microelectronics **SVSP20N60FJD(K)(T)(PN)(S)(P7)D2_Datasheet****ABSOLUTE MAXIMUM RATINGS (T_J=25°C, UNLESS OTHERWISE NOTED)**

Characteristics	Symbol	Ratings			Unit	
		SVSP20N60 FJDD2	SVSP20N60 KD2/TD2/SD2	SVSP20N60 PN/P7D2		
Drain-Source Voltage	V _{DS}	600		V		
Gate-Source Voltage	V _{GS}	±30		V		
Drain Current	T _C =25°C	I _D	20		A	
	T _C =100°C		12			
Drain Current Pulsed(Pulse time 5μs)	I _{DM}	80		A		
Power Dissipation(T _C =25°C) -Derate above 25°C	P _D	45	150	200	W	
		0.36	1.2	1.6	W/°C	
Single Pulsed Avalanche Energy (Note 1)	E _{AS}	967		mJ		
Reverse diode dv/dt (Note 2)	dv/dt	15		V/ns		
MOSFET dv/dt ruggedness (Note 3)	dv/dt	50		V/ns		
Operation Junction Temperature Range	T _J	-55~+150		°C		
Storage Temperature Range	T _{stg}	-55~+150		°C		

THERMAL CHARACTERISTICS

Characteristics	Symbol	Ratings			Unit
		SVSP20N60 FJDD2	SVSP20N60 KD2/TD2/SD2	SVS20PN60 PN/P7D2	
Thermal Resistance, Junction-to-Case	R _{θJC}	2.78	0.83	0.63	°C/W
Thermal Resistance, junction-to-Ambient	R _{θJA}	62.5	62.5	50.0	°C/W



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Microelectronics **SVSP20N60FJD(K)(T)(PN)(S)(P7)D2_Datasheet****ELECTRICAL CHARACTERISTICS (T_J=25°C, UNLESS OTHERWISE NOTED)**

Characteristics	Symbol	Test conditions		Min.	Typ.	Max.	Unit
Drain -Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V, I _D =250μA		600	--	--	V
Drain-Source Leakage Current	I _{bss}	V _{DS} =600V, V _{GS} =0V		--	--	1.0	μA
Gate-Source Leakage Current	I _{GSS}	V _{GS} =±30V, V _{DS} =0V		--	--	±100	nA
Gate Threshold Voltage	V _{GS(th)}	V _{GS} =V _{DS} , I _D =250μA		2.0	--	4.0	V
Static Drain-Source On State Resistance	R _{DS(on)}	V _{GS} =10V, I _D =10A	T _J =25°C T _J =125°C	--	0.16	0.19	Ω
Gate resistance	R _g	f=1.0MHz		--	2.6	--	Ω
Input Capacitance	C _{iss}	V _{DS} =100V, V _{GS} =0V, f=1.0MHz		--	1174	--	pF
Output Capacitance	C _{oss}			--	67	--	
Reverse Transfer Capacitance	C _{rss}			--	4.0	--	
Turn-on Delay Time	t _{d(on)}	V _{DD} =300V, V _{GS} =10V, R _G =25Ω, I _D =20A (Note 4, 5)		--	20	--	ns
Turn-on Rise Time	t _r			--	60	--	
Turn-off Delay Time	t _{d(off)}			--	105	--	
Turn-off Fall Time	t _f			--	42	--	
Total Gate Charge	Q _g	V _{DD} =480V, V _{GS} =10V, I _D =20A (Note 4, 5)		--	39	--	nC
Gate-Source Charge	Q _{gs}			--	9.6	--	
Gate-Drain Charge	Q _{gd}			--	20	--	

SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS

Characteristics	Symbol	Test conditions		Min.	Typ.	Max.	Unit
Continuous Source Current	I _s	Integral Reverse P-N Junction Diode in the MOSFET		--	--	20	A
Pulsed Source Current	I _{SM}			--	--	80	
Diode Forward Voltage	V _{SD}	I _s =20A, V _{GS} =0V		--	--	1.2	V
Reverse Recovery Time	T _{rr}	V _{DD} =50V, I _F =20A, dI _F /dt=100A/μs (Note 4)		--	426	--	ns
Reverse Recovery Charge	Q _{rr}			--	6.2	--	μC

Notes:

1. L=79mH, I_{AS}=4.6A, V_{DD}=100V, R_G=25Ω, starting T_J=25°C;
2. V_{DS}=0~400V, I_{SD}<=20A, T_J=25°C;
3. V_{DS}=0~480V;
4. Pulse Test: Pulse width ≤300μs, Duty cycle≤2%;
5. Essentially independent of operating temperature.



TYPICAL CHARACTERISTICS

Figure 1. On-Region Characteristics

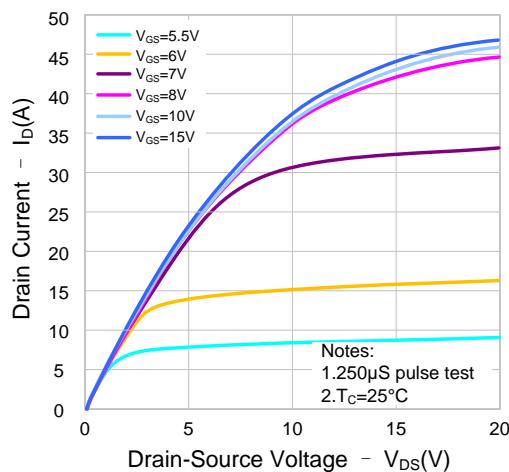


Figure 2. On-Region Characteristics

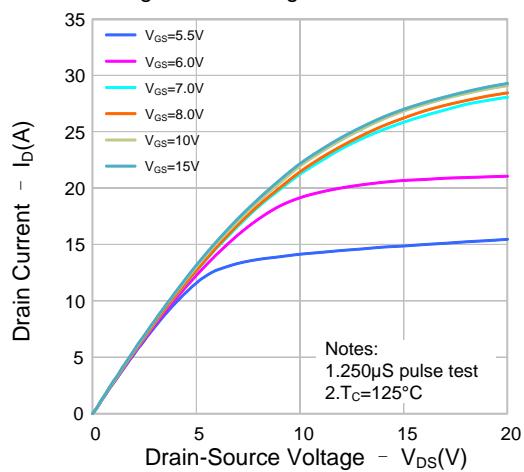


Figure 3. Transfer Characteristics

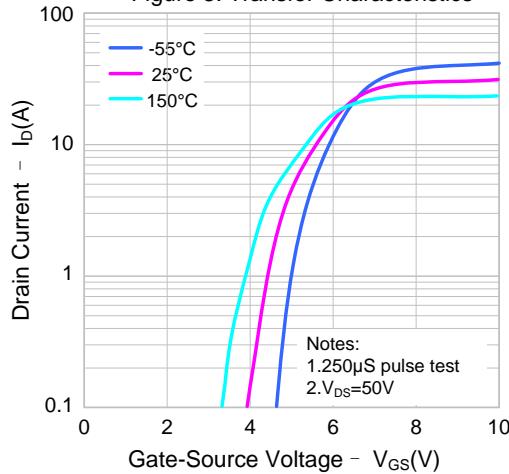


Figure 4. On-Resistance Variation vs. Drain Current

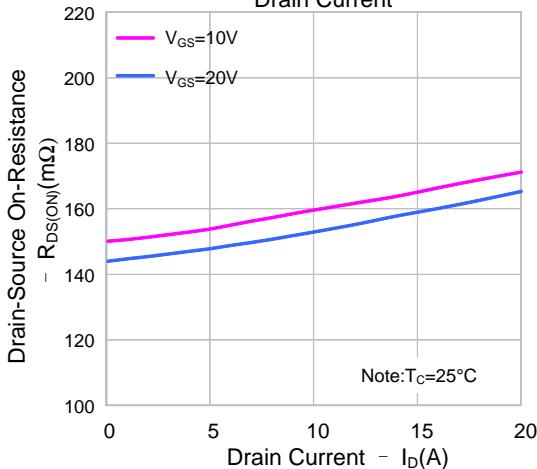


Figure 5. On-resistance vs. Gate-Source Voltage

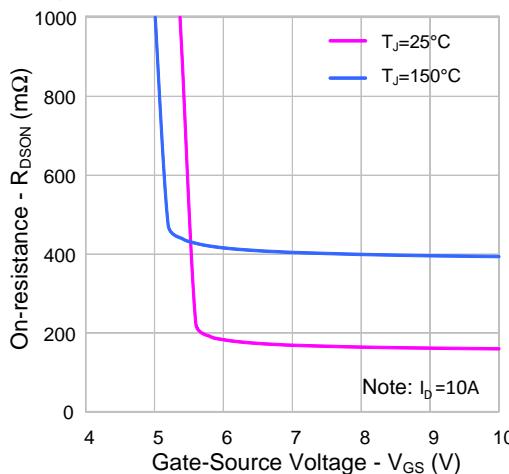
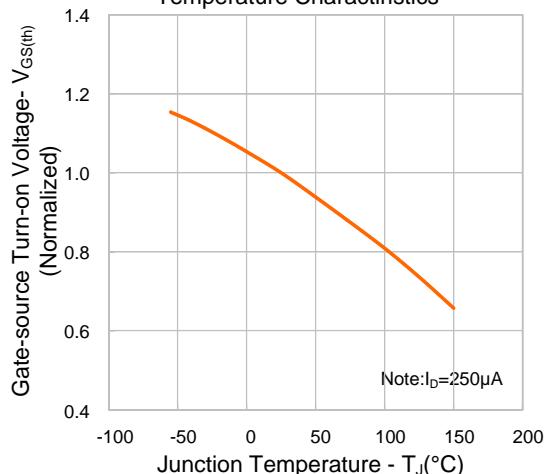
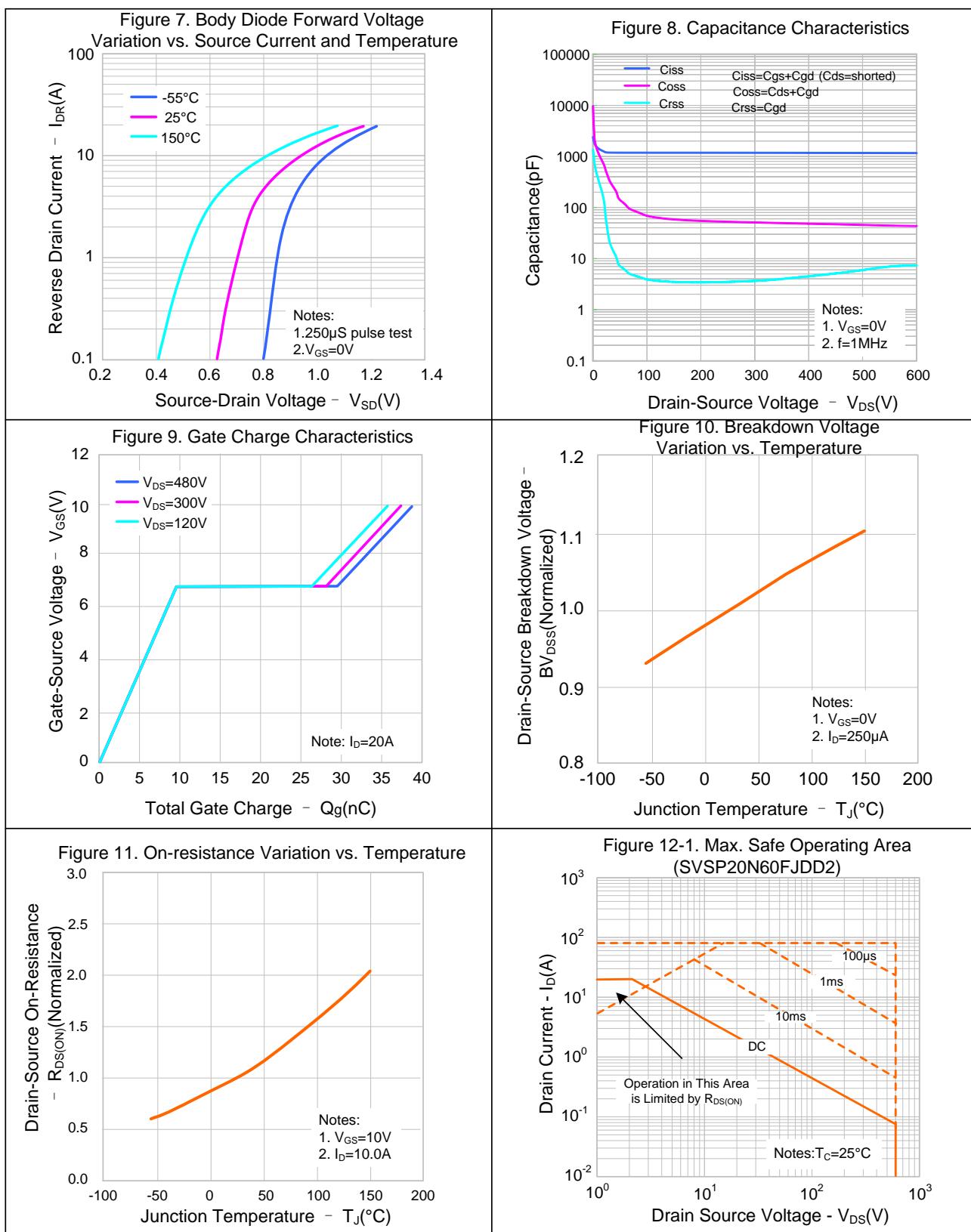


Figure 6. Gate-source Turn-on Voltage vs. Temperature Characteristics



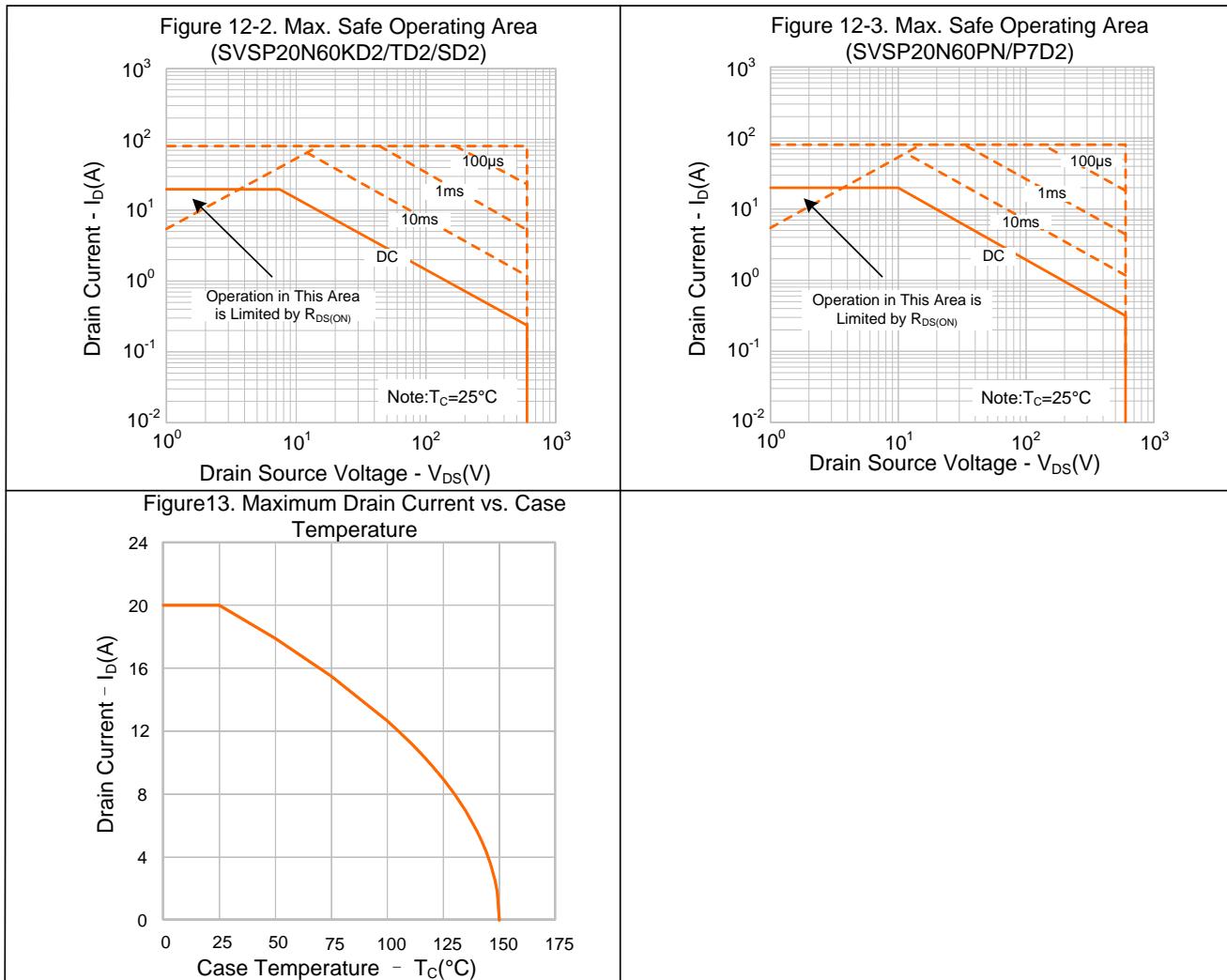


TYPICAL CHARACTERISTICS (CONTINUED)





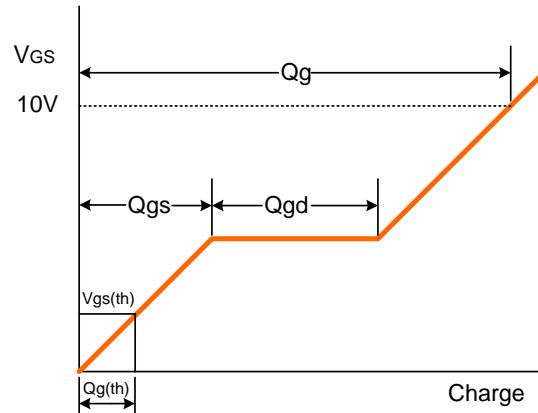
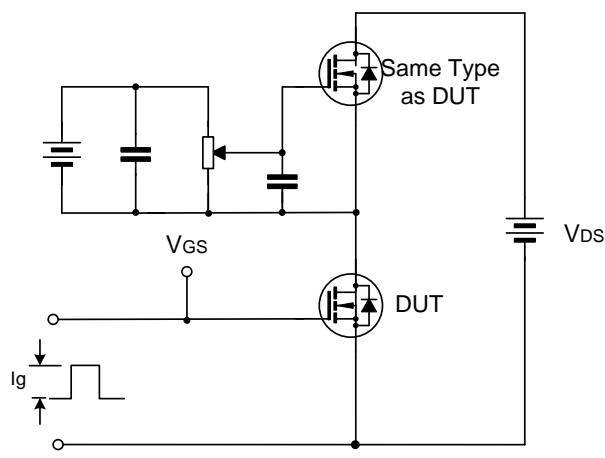
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Microelectronics **SVSP20N60FJD(K)(T)(PN)(S)(P7)D2_Datasheet****TYPICAL CHARACTERISTICS (CONTINUED)**

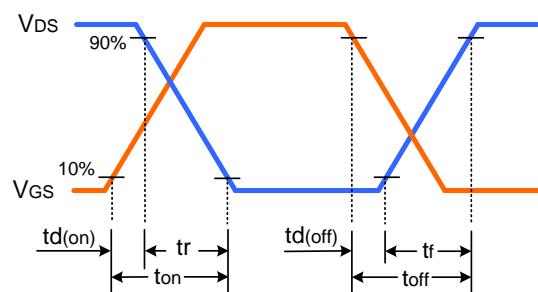
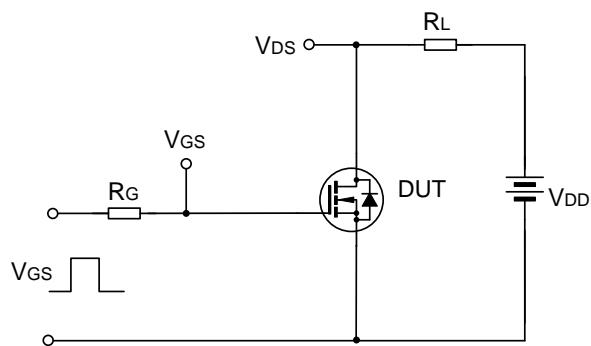


TYPICAL TEST CIRCUIT

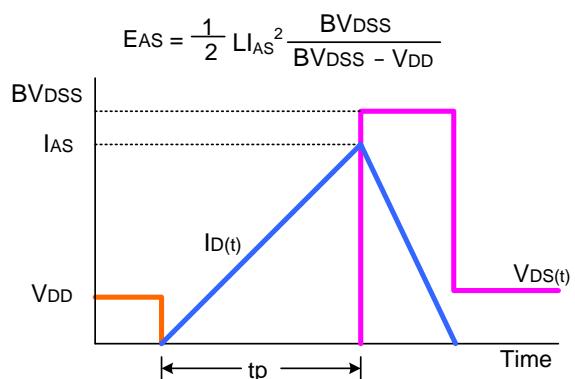
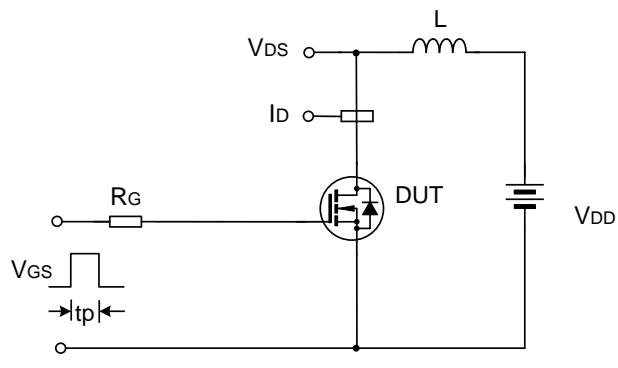
Gate Charge Test Circuit & Waveform



Resistive Switching Test Circuit & Waveform

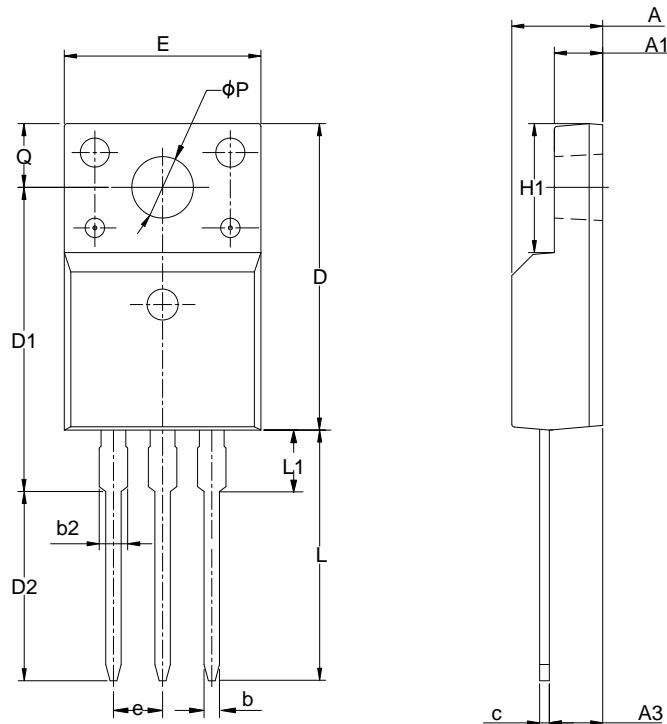


Unclamped Inductive Switching Test Circuit & Waveform

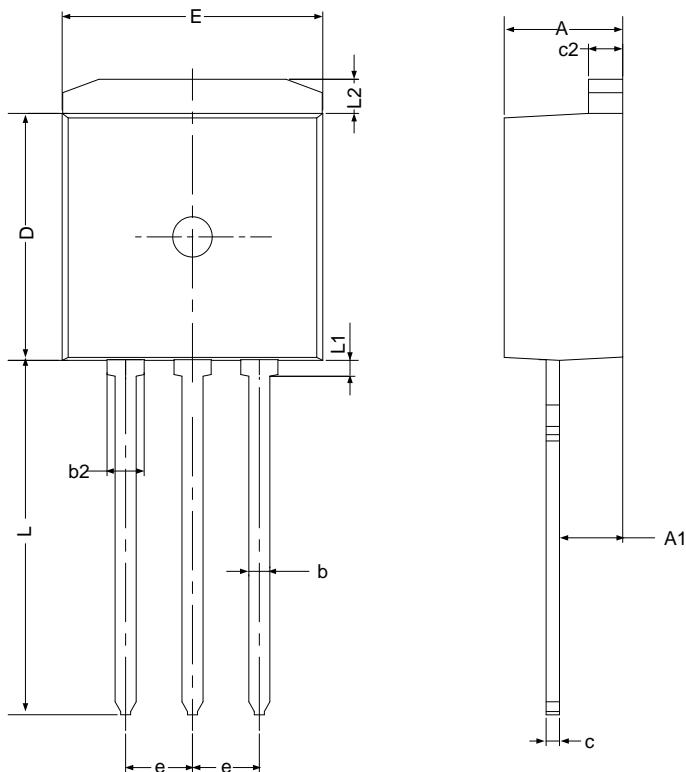




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Microelectronics **SVSP20N60FJD(K)(T)(PN)(S)(P7)D2_Datasheet****PACKAGE OUTLINE****TO-220FJD-3L****UNIT: mm**

SYMBOL	MILLIMETER		
	MIN	NOM	MAX
A	4.42	4.70	5.02
A1	2.30	2.54	2.80
A3	2.50	2.76	3.10
b	0.55	0.70	0.85
b2	—	—	1.29
c	0.35	0.50	0.65
D	15.25	15.87	16.25
D1	13.97	14.47	14.97
D2	10.58	11.08	11.58
E	9.73	10.16	10.36
e	2.54BSC		
H1	6.40	6.68	7.00
L	12.48	12.98	13.48
L1	—	—	2.00
φP	3.00	3.18	3.40
Q	3.05	3.30	3.55

TO-262-3L**UNIT: mm**

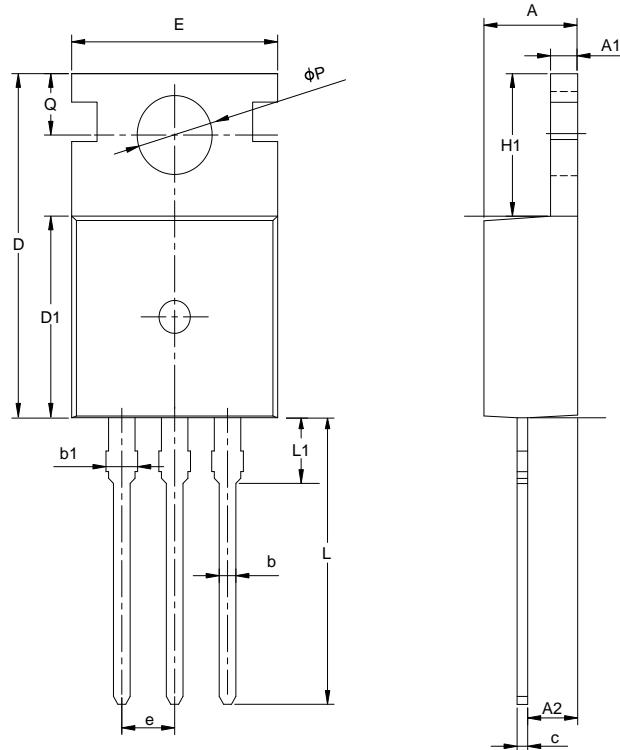
SYMBOL	MILLIMETER		
	MIN	NOM	MAX
A	4.30	4.50	4.70
A1	2.20	—	2.92
b	0.71	0.80	0.90
b2	1.20	—	1.50
c	0.34	—	0.65
c2	1.22	1.30	1.35
D	8.38	—	9.30
E	9.80	10.16	10.54
e	2.54 BSC		
L	12.80	—	14.10
L1	—	—	0.75
L2	1.12	—	1.42



PACKAGE OUTLINE(CONTINUED)

TO-220-3L

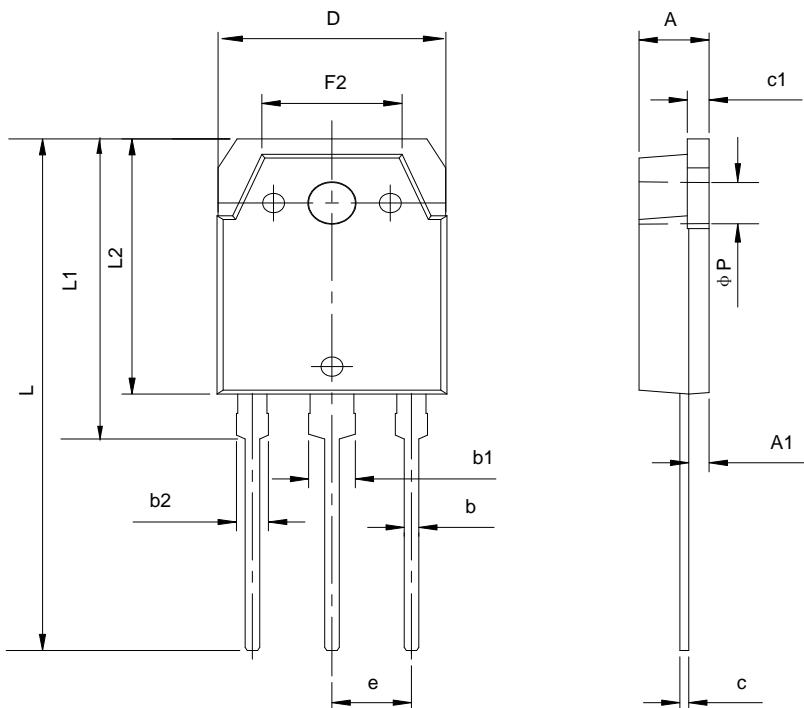
UNIT: mm



SYMBOL	MILLIMETER		
	MIN	NOM	MAX
A	4.30	4.50	4.70
A1	1.00	1.30	1.50
A2	1.80	2.40	2.80
b	0.60	0.80	1.00
b1	1.00	—	1.60
c	0.30	—	0.70
D	15.10	15.70	16.10
D1	8.10	9.20	10.00
E	9.60	9.90	10.40
e	2.54BSC		
H1	6.10	6.50	7.00
L	12.60	13.08	13.60
L1	—	—	3.95
φP	3.40	3.70	3.90
Q	2.60	—	3.20

TO-3P

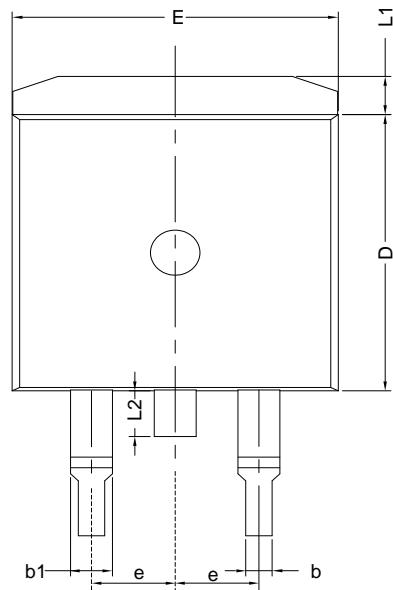
UNIT: mm



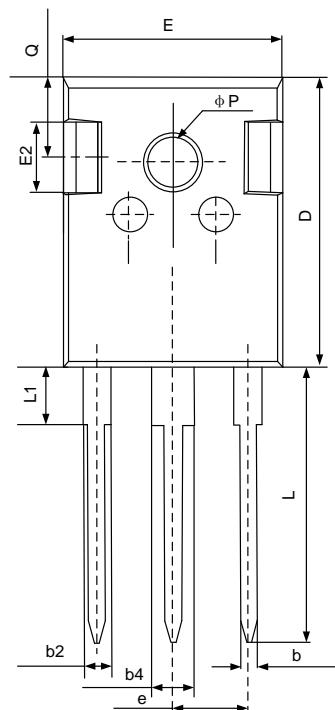
SYMBOL	MILLIMETER		
	MIN	NOM	MAX
A	4.4	—	5.2
c1	1.2	—	1.8
A1	1.2	—	2.0
b	0.7	1.0	1.3
b1	2.7	3.0	3.3
b2	1.7	2.0	2.3
D	15.0	15.5	16.0
c	0.4	0.6	0.8
F2	8.5	—	10.0
e	5.45 TYP		
L1	22.6	—	23.6
L	39.0	—	41.5
L2	19.5	—	21.0
P	3.0	—	3.4



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Microelectronics **SVSP20N60FJD(K)(T)(PN)(S)(P7)D2_Datasheet****PACKAGE OUTLINE(CONTINUED)****TO-263-2L****UNIT: mm**

SYMBOL	MILLIMETER		
	MIN	NOM	MAX
A	4.30	4.57	4.72
A1	0	0.10	0.25
b	0.71	0.81	0.91
b1	1.17	—	1.50
c	0.30	—	0.60
c2	1.17	1.27	1.37
D	8.50	—	9.35
E	9.80	—	10.45
e	2.54BSC		
H	14.70	—	15.75
L	2.00	2.30	2.74
L1	1.12	1.27	1.42
L2	—	—	1.75

TO-247-3L**UNIT: mm**

SYMBOL	MILLIMETER		
	MIN	NOM	MAX
A	4.80	5.00	5.20
A1	2.21	2.41	2.59
A2	1.85	2.00	2.15
b	1.11	—	1.36
b2	1.91	—	2.25
b4	2.91	—	3.25
c	0.51	—	0.75
D	20.80	21.00	21.30
E	15.50	15.80	16.10
E2	4.40	5.00	5.20
e	5.44 BSC		
L	19.72	19.92	20.22
L1	—	—	4.30
Q	5.60	5.80	6.00
P	3.40	—	3.80



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Microelectronics **SVSP20N60FJD(K)(T)(PN)(S)(P7)D2_Datasheet**

Important notice :

1. The instructions are subject to change without notice!
 2. Customers should obtain the latest relevant information before placing orders and should verify that such information is complete and current. Please read the instructions carefully before using our products, including the circuit operation precautions.
 3. Our products are consumer electronic products or the other civil electronic products.
 4. When using our products, please do not exceed the maximum rating of the products, otherwise the reliability of the whole machine will be affected. There is a certain possibility of failure or malfunction of any semiconductor product under specific conditions. The buyer is responsible for complying with safety standards and taking safety measures when using our products for system design, sample and whole machine manufacturing, so as to avoid potential failure risk that may cause personal injury or property loss.
 5. It is strongly recommended to identify the trademark when buying our products. Please contact us if there is any question.
 6. Product promotion is endless, our company will wholeheartedly provide customers with better products!
 7. Website: <http://www.silan.com.cn>
-

Part No.: **SVSP20N60FJD(K)(T)(PN)(S)(P7)D2**

Document Type: **Datasheet**

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Rev.: **1.3**

Revision History:

1. Add figures 2, 5, 6, and 13
 2. Update figure 4 and figure 8
 3. Update package outline of TO-3P, TO-263-2L, TO-247-3L
 4. Update curve template
 5. Update typical test circuit
 6. Update important notice
-

Rev.: **1.2**

Revision History:

1. Modify Electrical schematic and TYPICAL TEST CIRCUIT
-

Rev.: **1.1**

Revision History:

1. Update TYPICAL TEST CIRCUIT
-

Rev.: **1.0**

Revision History:

1. First release
-